

UF5400~UF5408

ULTRAFAST PLASTIC RECTIFIER

Reverse Voltage – 50 to 1000 Volts

Forward Current – 3.0 Amperes

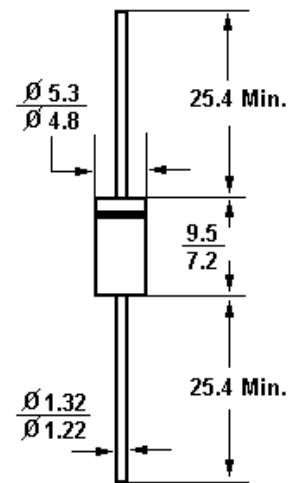
DO-201AD

Features

- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- Glass passivated chip junction
- Low cost
- Ultrafast recovery time for high efficiency
- High current capability, low forward voltage
- High surge capability
- Low leakage
- High temperature soldering guaranteed:
250°C/10 sec, 0.375" (9.5mm) lead length, 5lbs. (2.3kg) tension

Mechanical Data

- **Case:** Molded plastic body, JEDEC DO-201AD
- **Terminals:** Plated Axial leads, solderable per MIL-STD-750, method 2026
- **Polarity:** Color band denotes cathode end.
- **Mounting Position:** Any



Dimensions in mm

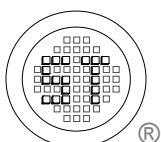
Absolute Maximum Ratings and Characteristics

Ratings at 25°C unless otherwise specified.

	Symbols	UF 5400	UF 5401	UF 5402	UF 5403	UF 5404	UF 5405	UF 5406	UF 5407	UF 5408	Units
Maximum recurrent peak reverse voltage	V_{RRM}	50	100	200	300	400	500	600	800	1000	V
Maximum RMS voltage	V_{RMS}	35	70	140	210	280	350	420	560	700	V
Maximum DC blocking voltage	V_{DC}	50	100	200	300	400	500	600	800	1000	V
Maximum average forward rectified current 0.375" (9.5mm) lead length at $T_A = 55^\circ\text{C}$	$I_{(AV)}$	3.0									A
Peak forward surge current 8.3mS single half sine-wave superimposed on rated load (JEDEC method) at $T_A = 55^\circ\text{C}$	I_{FSM}	150									A
Maximum instantaneous forward voltage at 3 A (Note 1)	V_F	1.0		1.3		1.7				V	
Maximum reverse current at rated reverse voltage	I_R	10									μA
Maximum reverse recovery time At $I_F = 0.5\text{A}$, $I_R = 1.0\text{A}$, $I_{rr} = 0.25\text{A}$, $T_J = 25^\circ\text{C}$	t_{rr}	50				75				ns	
Typical junction capacitance at 4.0V, 1MHz	C_{tot}	45			36					pF	
Typical thermal resistance (Note 2)	$R_{\theta JA}$ $R_{\theta JL}$	20 8.5						$^\circ\text{C/W}$			
Operating junction temperature range	T_J	-55 to +150									$^\circ\text{C}$
storage temperature range	T_S	-55 to +150									$^\circ\text{C}$

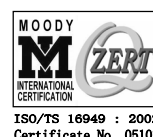
Notes:(1) Pulse test: 300 μs pulse width, 1% duty cycle

(2) Thermal resistance from junction to lead and from junction to ambient with 0.375" (9.5mm) lead length, both leads attached to heatsink.



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ISO/TS 16949 : 2002
Certificate No. 05103



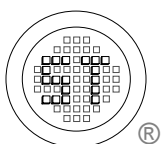
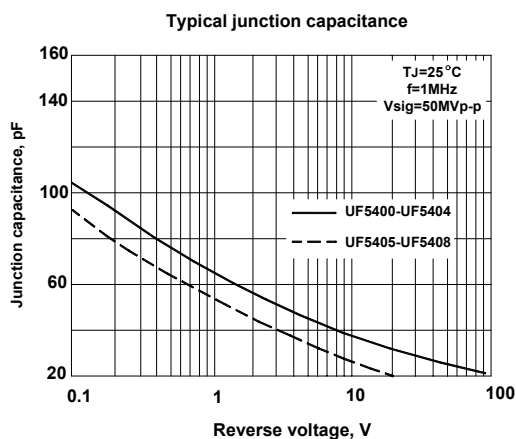
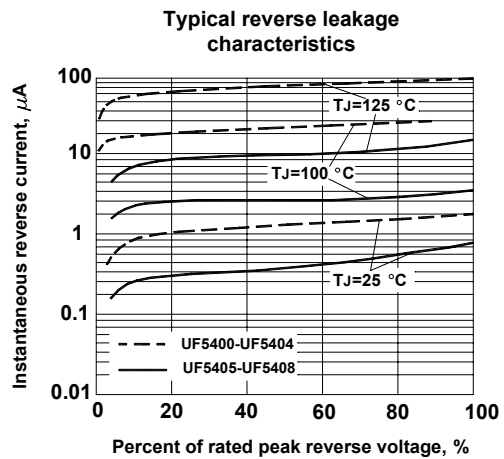
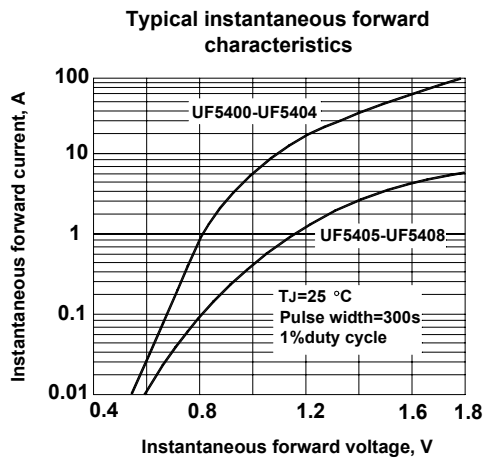
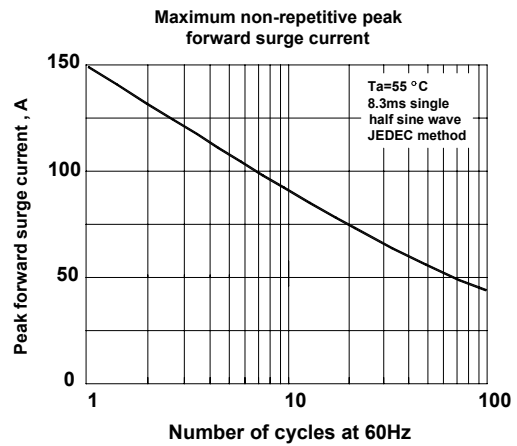
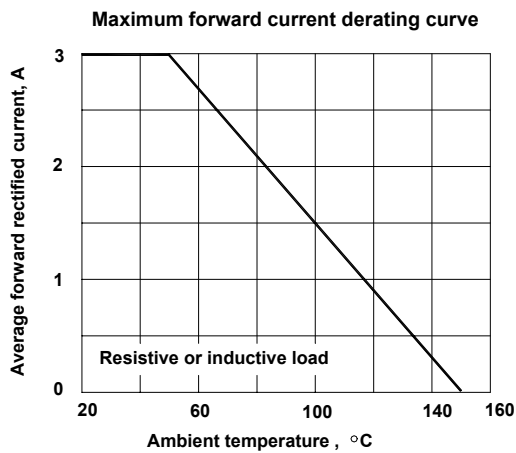
ISO 14001
Certificate No. 7116



ISO 9001 : 2000
Certificate No. 555-156-000-00

Dated : 04/07/2003

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